

## Surface Mount Schottky Barrier Rectifier Forward Current - 3.0A

### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View  
Simplified outline SMA and symbol

### Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

### MECHANICAL DATA

- Case: SMA
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 60mg / 0.0021oz

### Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	KCMSH3-40MA	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	40	V
Maximum RMS voltage	$V_{RMS}$	28	V
Maximum DC Blocking Voltage	$V_{DC}$	40	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	3.0	A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	$I_{FSM}$	80	A
Max Instantaneous Forward Voltage at 3 A	$V_F$	0.55	V
Maximum DC Reverse Current $T_a = 25^{\circ}C$ at Rated DC Reverse Voltage $T_a = 100^{\circ}C$	$I_R$	0.5 5	mA
Typical Junction Capacitance <sup>(1)</sup>	$C_j$	450	pF
Typical Thermal Resistance <sup>(2)</sup>	$R_{\theta JA}$	70	$^{\circ}C/W$
Operating Junction Temperature Range	$T_j$	-55 ~ +125	$^{\circ}C$
Storage Temperature Range	$T_{stg}$	-55 ~ +150	$^{\circ}C$

( 1 ) Measured at 1 MHz and applied reverse voltage of 4 V D.C

( 2 ) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Forward Current Derating Curve

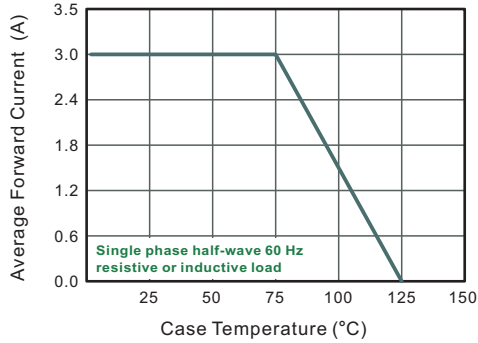


Fig.2 Typical Reverse Characteristics

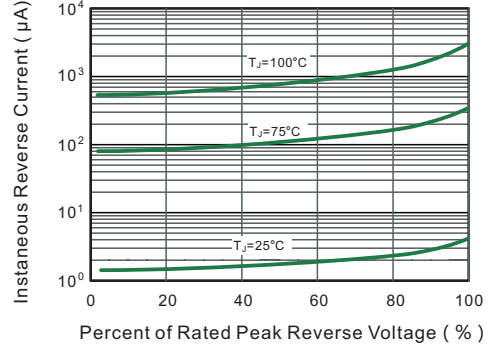


Fig.3 Typical Forward Characteristic

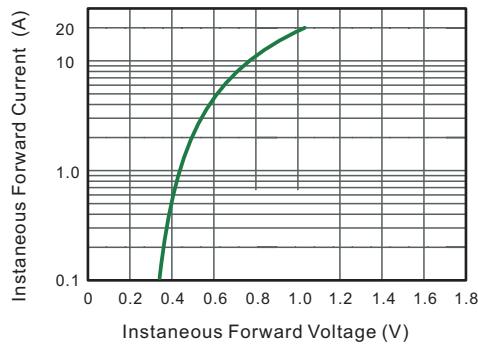


Fig.4 Typical Junction Capacitance

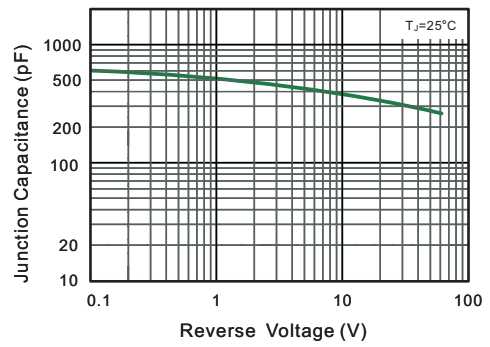


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

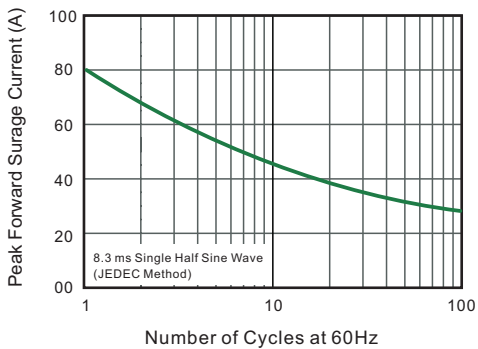
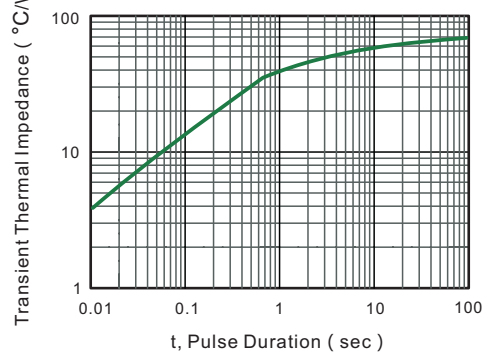


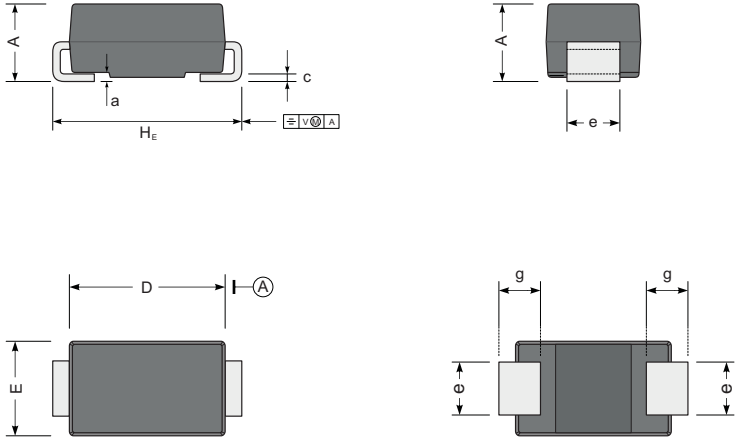
Fig.5- Typical Transient Thermal Impedance



**PACKAGE OUTLINE**

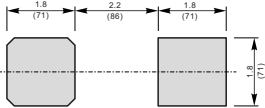
Plastic surface mounted package; 2 leads

SMA



UNIT		A	D	E	H <sub>E</sub>	c	e	g	a
mm	max	2.2	4.5	2.7	5.2	0.31	1.6	1.5	0.3
	min	1.9	4.0	2.3	4.7	0.15	1.3	0.9	
mil	max	87	181	106	205	12	63	59	12
	min	75	157	91	185	6	51	35	

**The recommended mounting pad size**



Unit :  $\frac{\text{mm}}{\text{(mil)}}$

单击下面可查看定价，库存，交付和生命周期等信息

[>>KUU\(永裕泰\)](#)